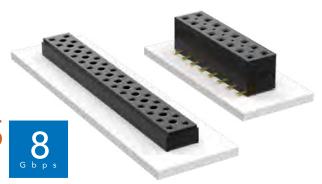
COST-EFFECTIVE & **DUAL WIPE SOCKETS**

(2.00 mm) .0787" PITCH • TLE/CLT SERIES



TLE Mates:

TMMH, TMM, MTMM, MMT, TW, LTMM, ZLTMM, TCMD, TSH

CLT Mates:

TMM, TMMH, MTMM, MMT, TW, TSH

SPECIFICATIONS

Insulator Material: Black Liquid Crystal Polymer Contact Material: Phosphor Bronze

Plating: Au over 50 μ" (1.27 μm) Ni Current Rating (TLE/TMMH):

3.2 A per pin (2 pins powered)

Operating Temp Range: -55 °C to +125 °C Insertion Depth:

(2.08 mm) .082" to (4.37 mm) .172" with (0.38 mm) .015" wipe, pass-through, or (3.35 mm) .132" min for bottom entry

CLT

Same as TLE except: Plating: Sn or Au over 50 μ" (1.27 μm) Ni Current Rating (TMMH/CLT):

4.1 A per pin (2 pins powered) Insertion Depth:

Top Entry= (1.40 mm) .055" minimum Bottom Entry= (2.57 mm) .101" minimum (add board thickness for

correct post OAL)
Max Cycles: 100 with 10 μ" (0.25 μm) Au

PROCESSING

TLE

Lead-Free Solderable:

Yes
SMT Lead Coplanarity: (0.10 mm) .004" max (02-26) (0.15 mm) .006" max (27-50)* *(.004" stencil solution may be available; contact IPG@samtec.com)

CLT

Same as TLE except: SMT Lead Coplanarity: (0.10 mm) .004" max (02-25) (0.15 mm) .006" max (26-34)* (0.20 mm) .008" max (35-50)* *(.004" stencil solution may be available; contact

LEAD STYLE

-01

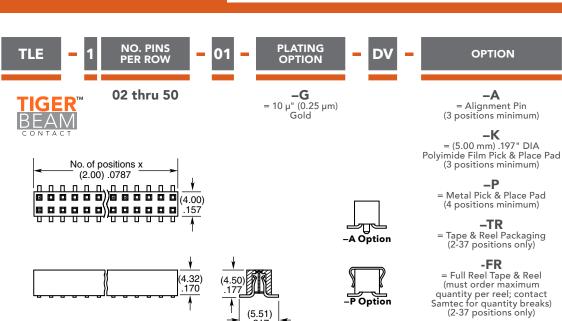
-03

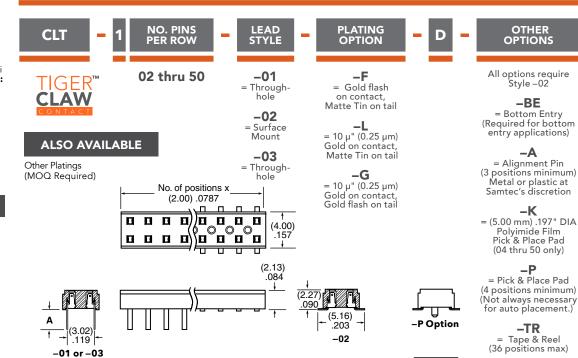
(2.16) .085

(2.95) .116

Some lengths, styles and options are non-standard, non-returnable.

IPG@samtec.com)





OPTIONS

Style –02

-BE

-K

-P

-TR

= Tape & Reel

-FR = Full Reel Tape & Reel (must order maximum

quantity per reel; contact Samtec for

quantity breaks) (36 positions max)

-A Option